Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Rev. 1 — 4 April 2013

Product data sheet

1. General description

The 74LVC125A-Q100 consists of four non-inverting buffers/line drivers with 3-state outputs (nY) that are controlled by the output enable input (n \overline{OE}). A HIGH at n \overline{OE} causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 2.3 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

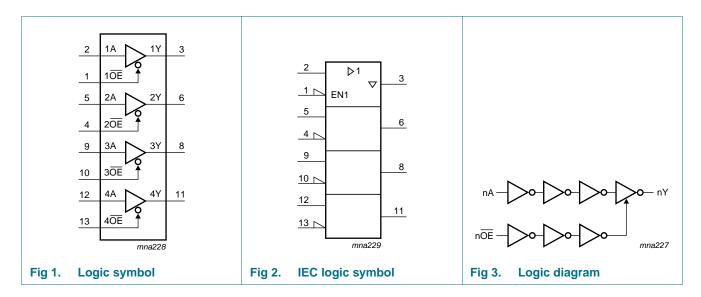


Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

3. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74LVC125AD-Q100	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm; body thickness 1.47 mm	SOT108-1			
74LVC125APW-Q100	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			
74LVC125ABQ-Q100	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	SOT762-1			

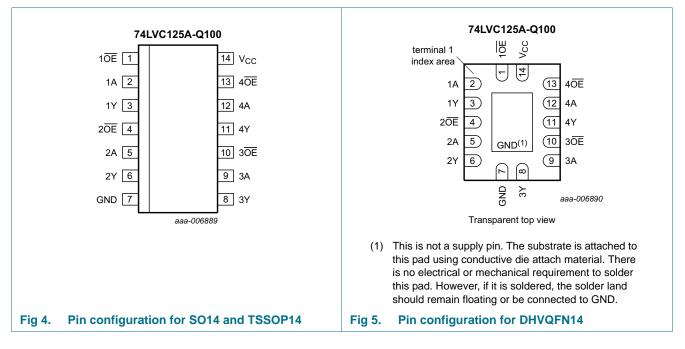
4. Functional diagram



Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin descri	ption	
Symbol	Pin	Description
$1\overline{OE}$, $2\overline{OE}$, $3\overline{OE}$, $4\overline{OE}$	1, 4, 10, 13	data enable input (active LOW)
1A, 2A, 3A, 4A	2, 5, 9, 12	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Dis deseriation

Table 3.Function selection^[1]

Inputs nOE	Output	
nOE	nA	nY
L	L	L
L	Н	Н
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

74LVC125A_Q100

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					-
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V	-	±50	mA
Vo	output voltage	output HIGH or LOW-state	[2] -0.5	V _{CC} + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[3] _	500	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

For SO14 packages: above 70 °C derate linearly with 8 mW/K.
 For TSSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	0	-	10	ns/V

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °	°C to +8	35 °C	–40 °C to +125 °C		Unit	
			Min	Typ[1]	Max	Min	Max		
ViH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V	
input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V		
	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V		
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
/ _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V	
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
/ _{ОН}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
/ _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$							
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V	
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V	
		I_{O} = 8 mA; V_{CC} = 2.3 V	-	-	0.6	-	0.8	V	
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V	
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA	
OZ	OFF-state output current	$ V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V}; $	-	±0.1	±5	-	±20	μA	
OFF	power-off leakage current	V_{CC} = 0.0 V; V _I or V _O = 5.5 V	-	±0.1	±10	-	±20	μA	
СС	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA	
Al _{CC}	additional supply current	per input pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 2.7 V to 3.6 V	-	5	500	-	5000	μA	
2	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V _I = GND to V _{CC}	-	4.0	-	-	-	pF	

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions		–40 °C to +85 °C			-40 °C to +125 °C		Unit
- ,			-	Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	nA to nY; see <u>Figure 6</u>	[2]		••		I	l	
		V _{CC} = 1.2 V		-	12.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	5.4	11.0	1.5	12.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.9	5.7	1.0	6.7	ns
		$V_{CC} = 2.7 V$		1.5	2.8	5.5	1.5	7.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.5	4.8	1.0	6.0	ns
t _{en}	enable time	nOE to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	16.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.0	5.0	12.2	1.0	14.2	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.9	6.8	0.5	7.9	ns
		$V_{CC} = 2.7 V$		1.5	3.1	6.6	1.5	8.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.3	5.4	1.0	7.0	ns
t _{dis}	disable time	nOE to nY; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	7.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	4.6	7.5	2.2	8.7	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.6	4.2	0.5	5.0	ns
		$V_{CC} = 2.7 V$		1.5	3.1	5.0	1.5	6.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.2	4.6	1.0	6.0	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per buffer; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V_{CC} = 1.65 V to 1.95 V		-	6.0	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V		-	9.4	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	12.4	-	-	-	pF

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_{L} = output load capacitance in pF

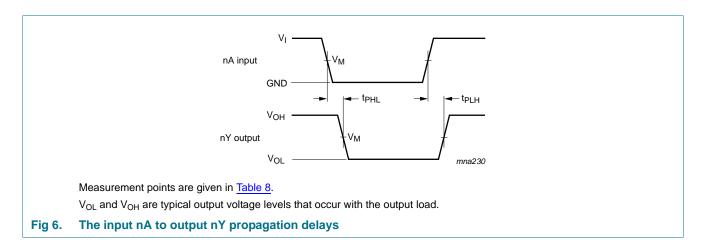
V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

11. AC waveforms



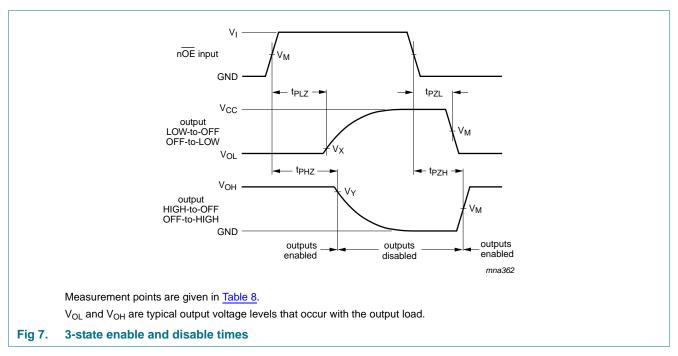
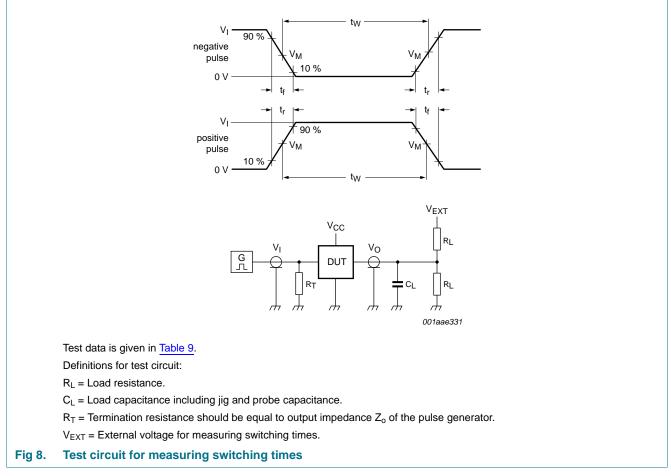


Table 8. Measurement points

Supply voltage	Input		Output
V _{CC}	VI	V _M	V _M
1.2 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$
1.65 V to 1.95 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$
2.3 V to 2.7 V	V _{CC}	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$
2.7 V	2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V

74LVC125A-Q100

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state



Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND	

74LVC125A-Q100

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

12. Package outline

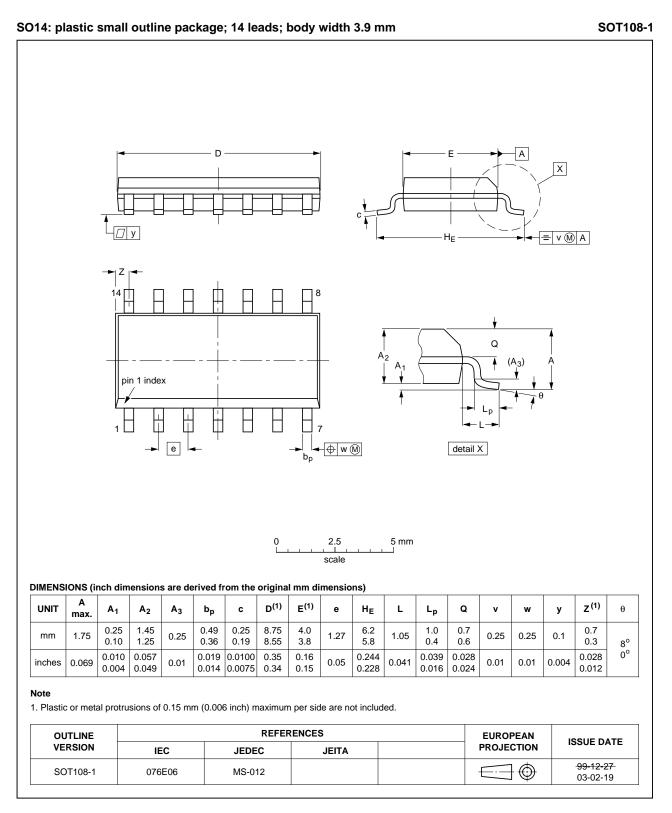


Fig 9. Package outline SOT108-1 (SO14)

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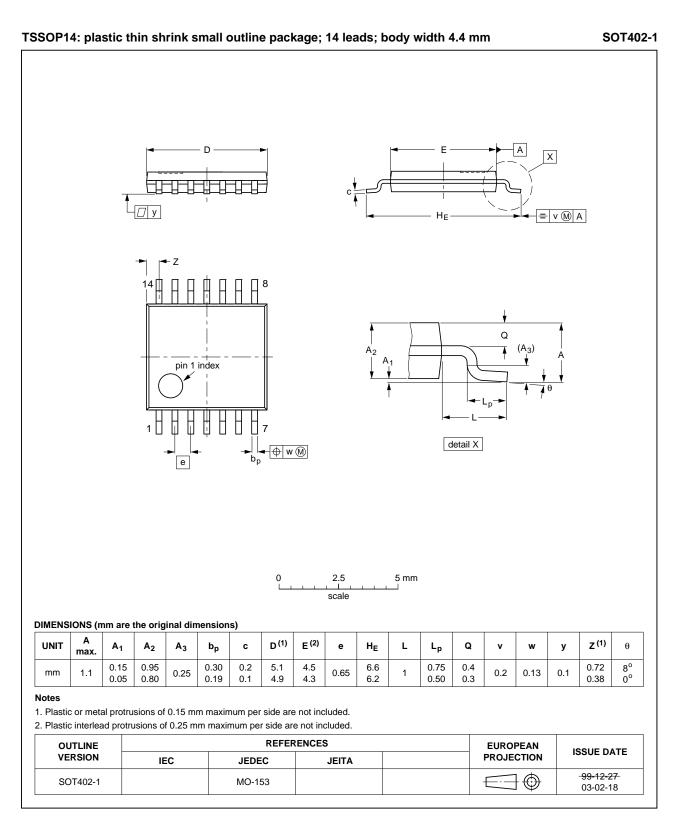
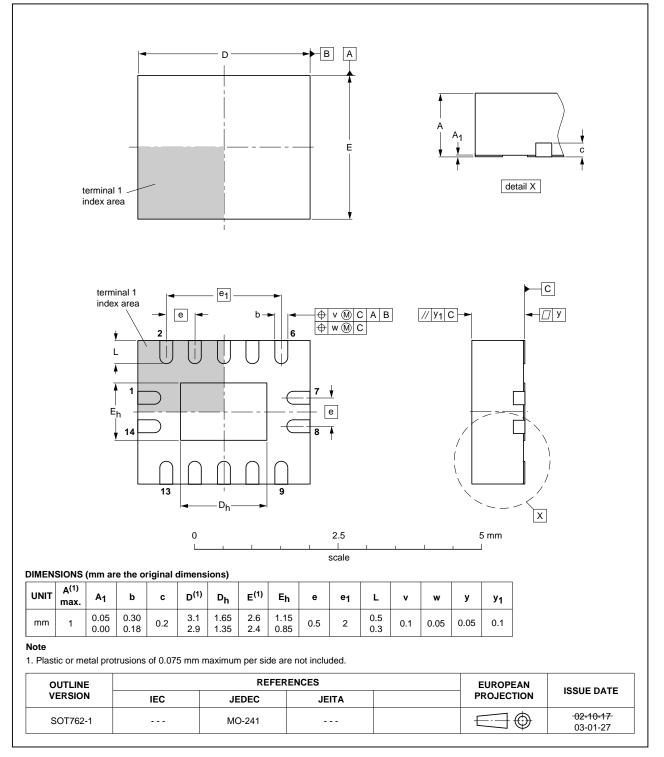


Fig 10. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 11. Package outline SOT762-1 (DHVQFN14)

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Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
MIL	Military
MM	Machine Model
HBM	Human Body Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC125A_Q100 v.1	20130404	Product data sheet	-	-	

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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74LVC125A-Q100

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

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74LVC125A-Q100

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 3
6	Functional description 3
7	Limiting values 4
8	Recommended operating conditions 4
9	Static characteristics 5
10	Dynamic characteristics 6
11	AC waveforms 7
12	Package outline 9
13	Abbreviations 12
14	Revision history 12
15	Legal information 13
15.1	Data sheet status 13
15.2	Definitions 13
15.3	Disclaimers
15.4	Trademarks 14
16	Contact information 14
17	Contents 15

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